Electronic Version v1.1

Stylesheet Version v1.1

	:	NEW ASSIGNMENT		
NATURE OF CONVE	YANCE:	ASSIGNMENT	ASSIGNMENT	
CONVEYING PARTY	′ DATA			
		Name	Execution Date	
Herren Wu			08/27/2008	
Changshou Gao			09/21/2008	
Ling-Ling An			09/04/2008	
Peter Kiener			08/27/2008	
Su-Yau Mao			08/28/2008	
Anthony Coyle			09/18/2008	
Jane Tian			08/29/2008	
Postal Code:	20878 RS Total: 1			
Property Type		Numbe	er	
Application Number: 12094447				
CORRESPONDENCI	E DATA			
		8-9306		
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Fax Number: <i>Correspondence will</i> Phone:	(301)39 <i>be sent via US</i> 301398	<i>Mail when the fax attempt is unsuccessf</i> 4156	ับไ.	
Fax Number: <i>Correspondence will</i> Phone: Email:	(301)39 <i>be sent via US</i> 301398 patents	<i>Mail when the fax attempt is unsuccessf</i> 4156 @medimmune.com	โป.	
Fax Number: <i>Correspondence will</i> Phone: Email: Correspondent Name	(301)39 <i>be sent via US</i> 301398 patents e: Jonatha	<i>Mail when the fax attempt is unsuccessf</i> 4156 @medimmune.com an Klein-Evans	โป.	
Fax Number: <i>Correspondence will</i> Phone: Email: Correspondent Name Address Line 1:	(301)39 <i>be sent via US</i> 301398 patents e: Jonatha One Me	<i>Mail when the fax attempt is unsuccessf</i> 4156 @medimmune.com an Klein-Evans edImmune Way	ย.	
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NAME OF SUBMITTER:	Audrey Clark
Total Attachments: 14	
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entitled:

HIGH AFFINITY ANTIBODIES AGAINST HMGB1 AND METHODS OF USE THEREOF

WHEREAS We, the below named inventors [hereinafter referred to as Assignors], have made an invention

for which an application for United States Letters Patent is filed herewith or an application for United States Letters Patent was filed as application no. 12/094,447 on May 21, 2008 as a U.S. National Stage Under 35 USC 371 from International application number PCT/US2006/061258, on November 27, 2006;

AND WHEREAS, MEDIMMUNE, LLC, a limited liability company formed under the laws of Delaware, whose post office address is One MedImmune Way, Gaithersburg, Maryland 20876, [hereinafter referred to as Assignee], is desirous of securing the entire right, title and interest in and to this invention in all countries throughout the world, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW, THEREFORE, be it known that, for and in consideration of the sum of one dollar (\$1.00) in hand paid and other good and valuable consideration the receipt of which from assignee, is hereby acknowledged, We, as assignors, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, Our entire right, title and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such application, and all applications for Letters patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals and reissues thereof; and We hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, We HEREBY covenant that We have the full right to convey the interest assigned by this Assignment, and WE or I have not executed and will not execute any agreement in conflict with this Assignment;

AND We HEREBY further covenant and agree that We will, without further consideration, communicate with assignee, its successors and assigns, any facts known to Us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by assignees, it successors and assigns.

Herren WU Full Name of First Inventor
14405 Harvest Moon Road Boyds. Maryland 20841 Address Address Assignor's Signature 8/27/08
Date
Changshou GAO Full Name of Second Inventor
<u>10822 Maplecrest Lane</u> <u>Potomac, Maryland 20854</u> Address
Assignor's Signature
Date

<u>14405 Harvest Moon Road</u> Boyds, Maryland 20841 Address

Assignor's Signature

Date

<u>Peter KIENER</u> Full Name of Fourth Inventor

<u>14017 Gorky Drive</u> <u>Potomac, Maryland 20854</u> Address

Assignor's Signature

Date

<u>Su-Yau MAO</u> Full Name of Fifth Inventor

7101 Cypress Hill Drive Gaithersburg, Maryland 20879 Address

Assignor's Signature

Date

Anthony COYLE Full Name of Sixth Inventor

<u>1155 23rd Street</u> Washington, District of Columbia 20037 Address

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Date

Jane TIAN Full Name of Seventh Inventor

11308 Coral Gables Drive North Potomac, Maryland 20878 Address

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Full Name o	f First	Inventor

<u>14405 Harvest Moon Road</u> <u>Boyds, Maryland 20841</u> Address

Assignor's Signature

Date

Changshou GAO Full Name of Second Inventor

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A1212008

Date

<u>14405 Harvest Moon Road</u> <u>Boyds, Maryland 20841</u> Address

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Herren WU	
Full Name of	First Inventor

14405 Harvest Moon Road Boyds, Maryland 20841 Address

Assignor's Signature

Date

<u>Changehou GAO</u> Full Name of Second Inventor

<u>10822 Maplecrest Lane</u> <u>Potomac, Maryland 20854</u> Address

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<u>Su-Yau MAO</u> Full Name of Fifth Inventor

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Jane TIAN Full Name of Seventh Inventor

<u>11308 Coral Gables Drive</u> North Potomac, Maryland 20878 Address

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and a second second	Herren WU Full Name of First Inventor
and the second s	<u>14405 Harvest Moon Road</u> Boyds, Maryland 20841 Address

Assignor's Signature

Date

<u>Changshou GAO</u> Full Name of Second Inventor

<u>10822 Maplecrest Lane</u> <u>Potomac, Maryland 20854</u> Address

Assignor's Signature

Date

Ling-Ling AN			
Full	Name of Third	Inventor	

14405 Harvest Moon Road Boyds, Maryland 20841 Address

Assignor's Signature

Date

Peter KIENER Full Name of Fourth Inventor

<u>14017 Gorky Drive</u> <u>Potomac, Maryland 20854</u> Addyess

mas Assignor's Signațure 081 2 08

Date

<u>Su-Yau MAO</u> Full Name of Fifth Inventor

7101 Cypress Hill Drive Gaithersburg, Maryland 20879 Address

Assignor's Signature

Date

Anthony COYLE Full Name of Sixth Inventor

<u>1155.23rd Street</u> Washington. District of Columbia 20037 Address

Assignor's Signature

Date

Jane TIAN Full Name of Seventh Inventor

11308 Coral Gables Drive North Potomac, Maryland 20878 Address

Assignor's Signature

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Herren WU	
Full Name of	First Inventor

<u>14405 Harvest Moon Road</u> <u>Boyds, Maryland 20841</u> Address

Assignor's Signature

Date

<u>Changshou GAO</u> Full Name of Second Inventor

10822 Maplecrest Lane Potomac, Maryland 20854 Address

Assignor's Signature

Date

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Peter KIENER Full Name of Fourth Inventor

14017 Gorky Drive Potomac, Maryland 20854 Address

Assignor's Signature

Date

Su-Yau MAO Full Name of Fifth Inventor

7101 Cypress Hill Drive Gaithersburg, Maryland 20879 Address Assignor's Signature

August 28, 2008

Anthony COYLE Full Name of Sixth Inventor

1155 23rd Street Washington, District of Columbia 20037. Address

Assignor's Signature

Date

Jane TIAN Full Name of Seventh Inventor

11308 Coral Gables Drive North Potomac, Maryland 20878 Address

Assignor's Signature

Atty Docket No. HB602US Sole/Joint Invention (Worldwide Rights)

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<u>14405 Harvest Moon Road</u> <u>Boyds, Maryland 20841</u> Address
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Date
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ì	
	Anthony COYLE
111111	Full Name of Sixth Inventor
Contractor	1155 23rd Street
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	Address ,
	And have
	Assignor's Signature
	18-5-14 08
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<u>Jane TIAN</u>	
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	North Potomac, Maryland 20878
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	Assignor's Signature
	8129/08
	Date

RECORDED: 10/02/2008